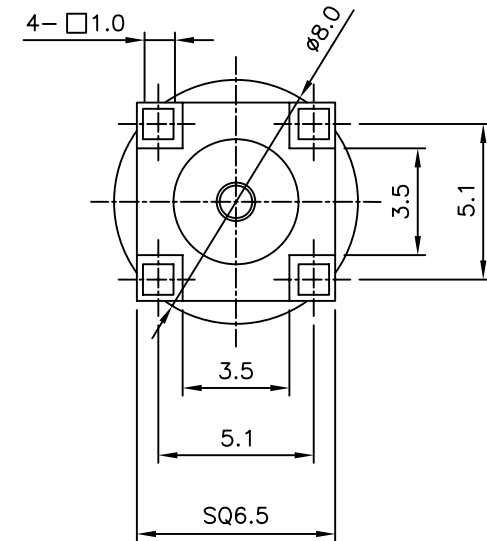
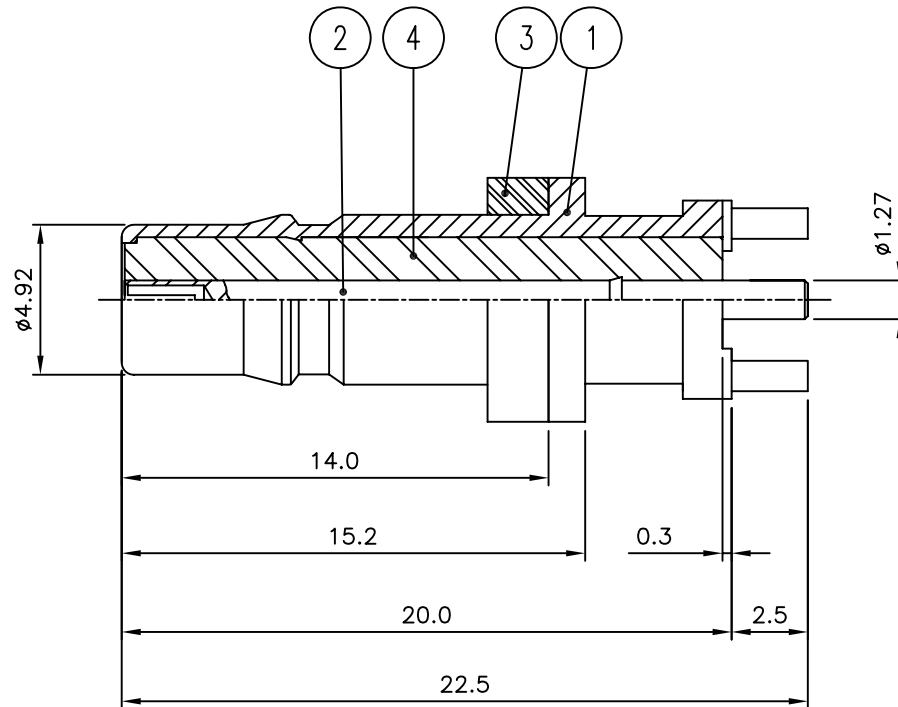


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2015.04.13.
1	[설번No.201504-0011] 업체 요청으로 인한 GASKET 제거	H.J.LEE	I.C.KIM	2015.04.28.
2	[설번No.201607-0003] 업체 요청으로 인한 GASKET 추가	H.J.LEE	I.C.KIM	2016.07.06.
3	[설번No.201806-0002] QMA 표준화 치수 변경	S.Y.EUN	I.C.KIM	2018.06.07.



4	INSULATOR	1	TEFLON		DIN02577-N/1
3	EMI GASKET	1	Carbon	BLACK	DGK00251-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03455-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD03923-5/2 DBD03923-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2018. 06. 07.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE KQMA50 PCB JS-4R
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	4/1	DWG NO. CN03414-7/2 REVISION 3 SHEET 1 of 1
		UNIT	mm	